BOARD CHARACTERISTICS

Copper Layer Count: 4 Board Thickness: 1,5900 mm

Board overall dimensions: 100,2000 mm x 75,2000 mm

Min track/spacing: 0,2500 mm / 0,2000 mm Min hole diameter: 0,3000 mm

Copper Finish: None Impedance Control: No Castellated pads: No Plated Board Edge: No

Edge card connectors: No

by: Hardik Rathod

https://github.com/hardikrathod4/Temperature-Data-Logger

OPENSOURCE (MIT License)

Sheet:

File: Temperature_Data_Logger.kicad_pcb

Title: 8 Channel K Thermocouple Temperature Data Logger

 Size: A4
 Date: 2022-01-05
 Rev: 1.0

 KiCad E.D.A. kicad (6.0.0)
 Id: 1/1